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**UTILITY PATENT APPLICATION TRANSMITTAL**  
**(Large Entity)**

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No.  
YOR9-2001-0467-US1

Total Pages in this Submission

**TO THE ASSISTANT COMMISSIONER FOR PATENTS**Box Patent Application  
Washington, D.C. 20231

Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for invention entitled:

**MAGNETIC-FIELD SENSOR HAVING MAGNETIC NANOPARTICLES**

and invented by:

- (1) Charles T. Black
- (2) Stephen M. Gates
- (3) Christopher B. Murray
- (4) Robert L. Sandstrom

If a **CONTINUATION APPLICATION**, check appropriate box and supply the requisite information:☐ Continuation ☐ Divisional ☐ Continuation-in-part (CIP) of prior application No.: \_\_\_\_\_

Which is a:

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Enclosed are:

**Application Elements**

1. ☒ Filing fee as calculated and transmitted as described below
2. ☒ Specification having 22 pages and including the following:
  - a. ☒ Descriptive Title of the Invention
  - b. ☐ Cross References to Related Applications (if applicable)
  - c. ☐ Statement Regarding Federally-sponsored Research/Development (if applicable)
  - d. ☐ Reference to Sequence Listing, a Table, or a Computer Program Listing Appendix
  - e. ☒ Background of the Invention
  - f. ☒ Brief Summary of the Invention
  - g. ☒ Brief Description of the Drawings (if filed)
  - h. ☒ Detailed Description
  - i. ☒ Claim(s) as Classified Below
  - j. ☒ Abstract of the Disclosure

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**Application Elements (Continued)**

3. ☒ Drawing(s) *(when necessary as prescribed by 35 USC 113)*
- a. ☒ Formal                      Number of Sheets      7 (Figs. 1a-5b)
- b. ☐ Informal                      Number of Sheets      \_\_\_\_\_
4. ☒ Oath or Declaration
- a. ☒ Newly executed *(original or copy)*      ☐ Unexecuted
- b. ☐ Copy from a prior application (37 CFR 1.63(d)) *(for continuation/divisional application only)*
- c. ☒ With Power of Attorney      ☐ Without Power of Attorney
- d. ☐ DELETION OF INVENTOR(S)  
Signed statement attached deleting inventor(s) named in the prior application,  
see 37 C.F.R. 1.63(d)(2) and 1.33(b).
5. ☐ Incorporation By Reference *(usable if Box 4b is checked)*  
The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under  
Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby  
incorporated by reference therein.
6. ☐ CD ROM or CD-R in duplicate, large table or Computer Program (Appendix)
7. ☐ Application Data Sheet (See 37 CFR 1.76)
8. ☐ Nucleotide and/or Amino Acid Sequence Submission *(if applicable, all must be included)*
- a. ☐ Computer Readable Form (CRF)
- b. ☐ Specification Sequence Listing on:
- i. ☐ CD-ROM or CD-R (2 copies); or
- ii. ☐ Paper
- c. ☐ Statement(s) Verifying Identical Paper and Computer Readable Copy

**Accompanying Application Parts**

9. ☒ Assignment Papers *(cover sheet & document(s))*
10. ☐ 37 CFR 3.73(B) Statement *(when there is an assignee)*
11. ☐ English Translation Document *(if applicable)*
12. ☒ Information Disclosure Statement/PTO-1449      ☒ Copies of IDS Citations
13. ☐ Preliminary Amendment
14. ☒ Return Receipt Postcard (MPEP 503) *(Should be specifically itemized)*
15. ☐ Certified Copy of Priority Document(s) *(if foreign priority is claimed)*
16. ☒ Certificate of Mailing
- ☐ First Class      ☒ Express Mail *(Specify Label No.):* EF255372656US

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Total Pages in this Submission

**Accompanying Application Parts (Continued)**

17. ☒ Additional Enclosures *(please identify below):*

Appointment of Associate Attorney

**Request That Application Not Be Published Pursuant To 35 U.S.C. 122(b)(2)**

18. ☐ Pursuant to 35 U.S.C. 122(b)(2), Applicant hereby requests that this patent application not be published pursuant to 35 U.S.C. 122(b)(1). Applicant hereby certifies that the invention disclosed in this application has not and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication of applications 18 months after filing of the application.

**Warning**

***An applicant who makes a request not to publish, but who subsequently files in a foreign country or under a multilateral international agreement specified in 35 U.S.C. 122(b)(2)(B)(i), must notify the Director of such filing not later than 45 days after the date of the filing of such foreign or international application. A failure of the applicant to provide such notice within the prescribed period shall result in the application being regarded as abandoned, unless it is shown to the satisfaction of the Director that the delay in submitting the notice was unintentional.***

**UTILITY PATENT APPLICATION TRANSMITTAL**  
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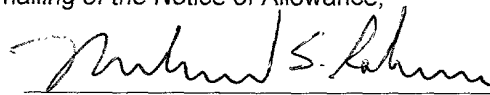
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**Fee Calculation and Transmittal**

**CLAIMS AS FILED**

For	#Filed	#Allowed	#Extra	Rate	Fee
Total Claims	28	- 20 =	8	x \$18.00	\$144.00
Indep. Claims	4	- 3 =	1	x \$84.00	\$84.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
BASIC FEE					\$740.00
OTHER FEE (specify purpose) _____					\$0.00
TOTAL FILING FEE					\$968.00

- ☐ A check in the amount of \_\_\_\_\_ to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge and credit Deposit Account No. **50-0510** as described below. A duplicate copy of this sheet is enclosed.
- ☒ Charge the amount of **\$968.00** as filing fee.
- ☒ Credit any overpayment.
- ☒ Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.
- ☐ Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).

  
Signature

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**APPLICATION DATA SHEET**  
**FOR**  
**UNITED STATES LETTERS PATENT**

**APPLICANT NAMES:**

**Charles T. Black  
Stephen M. Gates  
Christopher B. Murray  
Robert L. Sandstrom**

**TITLE:**

**MAGNETIC-FIELD SENSOR HAVING  
MAGNETIC NANOPARTICLES**

**DOCKET NO.:**

**YOR9-2001-0467-US1**

**ASSIGNEE NAME:**

**INTERNATIONAL BUSINESS  
MACHINES CORPORATION**

**ASSIGNEE RESIDENCE:**

**Armonk, New York**

# MAGNETIC-FIELD SENSOR HAVING MAGNETIC NANOPARTICLES

## BACKGROUND OF THE INVENTION

### *Field of the Invention*

[0001] The present invention generally relates to magnetic disc drives, and more particularly to magnetic-field sensor devices comprising magnetic nanoparticles.

### *Description of the Related Art*

[0002] Read-heads for magnetic disc drives currently sense magnetic bits by using an effect known as giant magnetoresistance (GMR). In essence, this type of sensor works because its resistance changes depending on the presence or absence of a magnetic field. The spatial resolution of such a device is limited by the dimensions of the active element in the sensor, which is currently defined lithographically. The GMR effect is described below.

[0003] One type of system which exhibits GMR is a magnetic tunnel junction. A magnetic tunnel junction is typically composed of two magnetic thin-film electrodes separated by a thin insulating layer. This insulating layer is sufficiently thin (~5 nm or less) to allow electrons

from one of the electrodes to move to the other electrode via quantum mechanical tunneling.

Important to the operation of the junction is that the tunneling process preserve the spin of tunneling electrons.

[0004] For the case of two magnetic electrodes composed of identical materials, the tunneling conductance (G) for electrons to move through the junction is proportional to:

$$G \sim 1 + P^2 \cos \theta$$

where P is the conduction electron polarization in the magnet (which is a measure of how magnetic the material is), and  $\theta$  is the relative angle between electrode magnetic moments. The resistance of the junction is the inverse of its conductance.

[0005] If the magnetic moment of one electrode is flipped relative to the other electrode, then the tunneling rate through the junction changes. This resistance change, caused by a change in a magnetic moment orientation, can be used to sense magnetic fields in the manner shown in Figures 1(a) and 1(b). The sensor 1 is positioned in close proximity to a magnetic field source 2. The sensor is made of a short length of magnetic material 3 sandwiched between two magnetic electrodes 4 and 5. The magnetic material used to sense the magnetic field 2 is electrically isolated from the two electrodes 4 and 5 by insulating tunnel barriers 6 and 7. Additionally, the material 3 is chosen so that its magnetic moment changes orientation at fields below that of the two electrodes 4 and 5.

[0006] In operation, an electric current 8 is made to flow through the device. Initially, the magnetic moments of the sensor material 3 and electrodes 4 and 5 are parallel. When the sensor comes into close proximity with a magnetic field of sufficient strength, the moment of material 3 is flipped relative to the two electrodes 4 and 5 leading to a measurable change in the current

through the device 8. The spatial resolution of such a sensor is directly related to the size of the sensor element 3. However, there is a need to improve the spatial resolution of such a magnetic field sensor, particularly in the area of read-heads for magnetic disc drives. Continually increasing storage densities demand the improved resolution.

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## SUMMARY OF THE INVENTION

[0007] In view of the foregoing and other problems, disadvantages, and drawbacks of the conventional magnetic sensor devices, the present invention has been devised, and it is an object of the present invention, to provide a structure and method for improving the spatial resolution of a magnetic-field sensor device.

[0008] In order to attain the object suggested above, there is provided, according to one aspect of the invention, a structure and method for forming a magnetic-field sensor device that comprises first depositing a first electrode onto a substrate. Then, an electrically insulating layer is deposited on the first electrode. Next, a portion of the electrically insulating layer is removed to expose a region of the first electrode, thereby creating an empty space. After this, at least one layer of chemically-synthesized nanoparticles is deposited on the electrically insulating layer and within the empty space created by the removal of a portion of the electrically insulating layer.

[0009] Upon completion of this step, a second electrode is deposited on both the layer of chemically-synthesized nanoparticles and the electrically insulating layer. Alternatively, multiple layers of nanoparticles may be deposited, or only a single nanoparticle may be deposited, depending on the desired application. The substrate is formed of conducting or non-conducting



material, and the first and second electrodes are formed of electrically conducting and magnetic or non-magnetic material. Additionally, a metallic layer of magnetic material may be deposited on the substrate prior to the first electrode being deposited thereon. Alternatively, the magnetic-field sensor device may be formed by first depositing a first electrode onto a substrate. Then, an electrically insulating layer is deposited on the first electrode.

[0010] Next, a second electrode is deposited on the electrically insulating layer. After this, a portion of the electrically insulating layer is removed, thereby creating an empty space. Upon completion of this step, at least one layer of chemically-synthesized nanoparticles is deposited in the empty space; and finally, the substrate is removed. Again, multiple layers of nanoparticles may be deposited, or only a single nanoparticle may be deposited, depending on the desired application.

[0011] The inventive structure (sensor) has several advantages over conventional devices. First, the critical dimension is about 5 to 50 nm and is well-matched to the bit area required for storage at areal densities  $>100$  Gbit/in<sup>2</sup>. Second, the critical dimension is 5 to 50 nm and is beyond the resolution of current lithographic methods, and is controlled through chemical size separation methods (not through deposition thickness control, and not through lithography). Also, the methods described herein are readily scaled to a large scale production, and the methods use less vacuum-based process equipment than the conventional devices and, hence, the present methods result in lower fabrication costs.

## BRIEF DESCRIPTION OF THE DRAWINGS

[0012] The foregoing and other objects, aspects and advantages will be better understood from the following detailed description of a preferred embodiment(s) of the invention with reference to the drawings, in which:

5 [0013] Figure 1(a) is a schematic diagram of a conventional magnetic-field sensor device;

[0014] Figure 1(b) is a schematic diagram of a magnetic object and the magnetic field it produces;

[0015] Figure 2(a) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0016] Figure 2(b) is a top view schematic diagram of a magnetic-field sensor device according to the present invention;

[0017] Figure 2(c) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

15 [0018] Figure 2(d) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0019] Figure 3(a) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0020] Figure 3(b) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

20 [0021] Figure 3(c) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0022] Figure 3(d) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0023] Figure 3(e) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

5 [0024] Figure 3(f) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0025] Figure 3(g) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

10 [0026] Figure 3(h) is a side view schematic diagram of a magnetic-field sensor device according to the present invention;

[0027] Figure 3(i) is a flow diagram illustrating a preferred method of the invention as described in Figures 3(a) through 3(h);

20 [0028] Figure 4(a) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

15 [0029] Figure 4(b) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

[0030] Figure 4(c) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

20 [0031] Figure 4(d) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

[0032] Figure 4(e) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

[0033] Figure 4(f) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

[0034] Figure 4(g) is a side view schematic diagram of an alternate embodiment of a magnetic-field sensor device according to the present invention;

5 [0035] Figure 4(h) is a flow diagram illustrating an alternate method of the invention as described in Figures 4(a) through 4(g);

[0036] Figure 5(a) is a plot of the device resistance versus the magnetic field according to the present invention; and

[0037] Figure 5(b) is a plot of the device resistance versus the magnetic field according to the present invention.

## **DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS OF THE INVENTION**

15 [0038] As mentioned, there is a need for improving the spatial resolution of magnetic-field sensor devices. The present invention discloses a magnetic-field sensor device based on electron tunneling through chemically-synthesized magnetic nanoparticles (or nanocrystals). Such nanoparticles are made with extreme uniformity (standard deviations in diameter of  $< 10\%$ , and optimally  $< 5\%$ ) with nanometer-scale dimensions (diameters from 2-20 nm). Details of the synthesis of such magnetic nanoparticles have been disclosed previously (U.S. Patent 6,162,532), the complete disclosure of which is herein incorporated by reference.

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5 [0039] Nanoparticles with diameters ranging from 2 nm to 20 nm can be made out of a wide variety of organic and inorganic materials (C. B. Murray, D. J. Norris, M. G. Bawendi, *J. Am. Chem. Soc.*, 115, 8706 (1993), L. Brus in "Materials Chemistry: An Energy Discipline," G. A. Ozin, 335 (ACS Sympos. Ser. No. 245, 1995)). Nanoparticles are a subclass of nanoparticles composed of well-characterized, crystalline cores and thin organic coats. Nanoparticles are monodisperse in terms of their size, internal structure (lattice), surface chemistry, and shape. Nanoparticles dispersed in liquids and nanoparticles deposited on solid substrates have provided much information on the submicroscopic properties of materials (A. P. Alivisatos, *Science* 271, 933 (1996)). Sensors employing such nanoparticles as their active elements have improved spatial resolutions because the nanoparticles have dimensions which are smaller and can be defined lithographically. The sensor devices disclosed herein operate using the giant magnetoresistance effect, which has been previously described.

15 [0040] In order to improve the spatial resolution of such a magnetic sensor device, conventional devices are constructed using chemically-synthesized magnetic nanoparticles. The structure and composition of nanoparticles are fully discussed in U.S. Patent 6,162,532. These nanoparticles can be synthesized of different magnetic materials and have precisely-controlled sizes ranging from as small as approximately 2 nm up to approximately 20 nm, depending on the application. The nanoparticle diameters can be controlled to standard deviations less than 15%, and preferably less than 10%. Optimally, the present invention controls nanoparticle diameters 20 to standard deviations within less than 5%.

[0041] In order to do this, the present invention comprises sensors made using magnetic nanoparticles synthesized via the means of U.S. Patent 6,162,532. As such, the size distributions

of the nanoparticles can be narrowly defined, for example, <15%, <10%, <5%. The nanoparticles preferably comprise magnetic materials such as Co, Fe, Ni, Mn, Cr, Nd, Pr, Pt, Pd, Ho, Gd, Eu, Er, Re, Rh, an intermetallic compound of these elements, a binary alloy of these elements, a ternary alloy of these elements, an oxide of Fe, Co, Ni, Mn, or Cr, and a mixed oxide combining at least one of Fe, Co, Ni, Mn, or Cr, with at least one of La, Sr, Ba, or Cu.

[0042] Referring now to the drawings, and more particularly to Figures 2(a) through 5(b), there are shown preferred embodiments of the method and structures according to the present invention. In Figures 2(a) through 2(d), a first embodiment of the present invention is shown. Specifically, in Figure 2(a), which shows the side view, and Figure 2(b), which shows the top view, two magnetic electrodes 11 and 12 are separated from each other by an electrically-insulating layer 13, except for a small area 5 (of length  $\lambda$ ) near the ends of the electrodes. A layer of chemically-synthesized nanoparticles 9 is disposed in the small area 5. Each nanoparticle 9 has a magnetic moment. Furthermore, these nanoparticles 9 are electrically-isolated from the electrodes 11 and 12 and from each other by an organic spacer 10 which acts as a tunnel barrier for electrons. This layer of nanoparticles 9 may be a single sheet (as shown) or may also be several nanoparticle layers thick.

[0043] In addition, it is possible to control the nanoparticle magnetic moment orientation during deposition of the nanoparticle film, for example, by depositing the nanoparticles 9 while applying an external magnetic field. Depending on the application, the nanoparticle moments may be oriented in the two directions (denoted by the arrows) shown in Figure 2(c) as parallel (for sensing longitudinal fields) or in Figure 2(d) as perpendicular (to sense perpendicular fields) to the surface above which the sensor will be used.

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[0044] The device operation is similar to that described above. A current (I) 14 is applied to flow through the device. Electrons travel from one electrode to the other only by tunneling through the organic spacers 10 and onto the individual nanoparticles 9. The device resistance depends on the relative orientations of the electrode magnetic moments to the nanoparticle magnetic moments. Through choice of nanoparticle and electrode materials, the nanoparticle moments are made to flip at a lower magnetic field than that required to flip the electrode moments. Thus, a magnetic field sensor is created whose spatial resolution is set by the nanometer size-scale of the chemically-synthesized nanoparticles, thereby increasing the overall spatial resolution.

[0045] There are several different possible embodiments of such a device, each of which are described herein. First, as previously described, two magnetic electrodes 11, 12 are separated by an insulating layer 13. In the empty space 5 near the end of the sensor, there is deposited a single layer of chemically-synthesized magnetic nanoparticles 9. The nanoparticles range in sizes (diameters) from approximately 2 nm up to approximately 20 nm.

[0046] Second, the same device as described in the first embodiment above is disclosed, except that the nanoparticles 9 are deposited with a preferred magnetic-moment orientation that is parallel to the direction of current flow through the nanoparticles 9 (see Figure 2(c)). Third, the same device as described in the first embodiment above is disclosed, except that the nanoparticles 9 are deposited with a preferred magnetic-moment orientation that is perpendicular to the direction of current flow through the nanoparticles 9 (see Figure 2(d)). Fourth, the same devices as described in the first, second, and third embodiments above are disclosed, except that only one of the two electrodes 11, 12 is magnetic. The other device(s) can be any non-magnetic

metal or semiconductor. Fifth, the same device as described in the first embodiment above is disclosed wherein the two magnetic electrodes 11, 12 are separated by an insulating layer 13. In the first embodiment, in the empty space 5 near the end of the sensor, there is deposited a layer of chemically-synthesized magnetic nanoparticles 9. However, in this fifth embodiment, the layer of nanoparticles 9 is more than one layer thick. Sixth, the same device as described in the fifth embodiment above is disclosed, except that the nanoparticles 9 are deposited with a preferred magnetic-moment orientation that is parallel to the direction of current flow through the nanoparticles 9. Seventh, the same device as described in the fifth embodiment above is disclosed, except that the nanoparticles 9 are deposited with a preferred magnetic-moment orientation that is perpendicular to the direction of current flow through the nanoparticles 9. Eighth, the same device as described in the fifth embodiment above is disclosed, expect that only one of the two electrodes 11, 12 is magnetic. The other electrode can be any non-magnetic metal or semiconductor. Ninth, the same device as described in the fifth embodiment above is disclosed, except that neither electrode 11, 12 is magnetic. The electrodes 11, 12 may be any non-magnetic metal or semiconductor. Tenth, the same devices as described in the first through the ninth embodiments are disclosed, except that the space 5 near the end of the sensor is not completely filled with a layer of chemically-synthesized nanoparticles 9. Eleventh, the same devices as described in the first through the ninth embodiments are disclosed, except that the empty space 5 near the end of the sensor ( $\lambda$ ) is made only wide enough to fit a single chemically-synthesized nanoparticle 9. Twelfth, the same devices as described in the first through the eleventh embodiments are disclosed, except that the width of the device is the same as the width of a single, chemically- synthesized nanoparticle 9.



[0047] Any and all of the above embodiments and the structures described therein may be fabricated in several different ways. The first such method is illustrated in Figures 3(a) through 3(i). Each of the structural components are also shown in Figures 3(a) through 3(h). Furthermore, the entire process is shown in a flowchart in Figure 3(i).

5 [0048] First, as shown in Figure 3(a), the process begins 30 with a substrate 15. The substrate can be any flat surface, and may be conducting or non-conducting. Preferably, this substrate is composed of silicon, silicon dioxide, silicon nitride, glass, or ceramic material.

[0049] Next, as shown in Figure 3(b), a bottom metallic layer (electrode) 11 is deposited 32 onto the substrate 15. This layer is composed of a soft magnetic material and is typically between 10 and 30 nm thick. Preferably, the electrode material is composed of permalloy NiFe or NiFeCo. This bottom electrode layer may or may not have an antiferromagnetic underlayer (typically between 10-30 nm thick) used to pin the magnetization of the bottom electrode. Antiferromagnetic layers are typically composed of MnFe, CoO, NiFeTb, NiO, or a synthetic antiferromagnet composed of two magnetic layers separated by a thin Ru layer.

15 [0050] The bottom electrode 11 is deposited 32 onto the substrate 15, as illustrated in Figure 3(b). This electrode 11 is electrically conducting and may be magnetic or non-magnetic, depending on choice of device type, as previously indicated above. Figure 3(c) then shows an electrically insulating layer 13 being deposited or grown 33 on top of the bottom electrode 15.

[0051] After this, a region of the insulating layer 13 is patterned 34 and etched 35, thereby forming an empty space 5, and exposing a region of the bottom electrode 11, which is shown in Figure 3(d). Next, as depicted in Figure 3(e), a layer of nanoparticles 9 is deposited 36 onto the structure, covering both the exposed bottom electrode 11 and insulating layer 13. The

nanoparticles 9 may be separated from each other by an insulating organic layer 10. The nanoparticle layer 9 may be either one or several layers thick, depending on the type of device being fabricated. As such, nanoparticles 9 may or may not be removed 37 from the insulating spacer layer 13, once again, depending on whether one or several layers of nanoparticles 9 are desired. Figure 3(f) shows only a single layer of nanoparticles 9 left in the empty space 5.

[0052] Upon completion of this step, a top electrode 12 is deposited 38 on top of the nanoparticle layer 9 and the insulating layer 13, as shown in Figure 3(g). The top electrode 12 is electrically conducting and may or may not be magnetic, depending on the type of device being fabricated. Figure 3(h) shows the device with the substrate 15 removed.

[0053] An alternative method is illustrated in Figures 4(a) through 4(h). Each of the structural components are also shown in Figures 4(a) through 4(g). Furthermore, the entire process is shown in a flowchart in Figure 4(h).

[0054] As with the previous embodiment and as shown in Figure 4(a), the process begins 40 with a flat substrate 15. The substrate can be any flat surface and may be conducting or non-conducting. Preferably, this substrate is composed of silicon, silicon dioxide, silicon nitride, glass, GaAs, sapphire ( $\text{Al}_2\text{O}_3$ ) or ceramic material. The bottom metallic layer 11 is also called the bottom electrode layer 11. The bottom electrode layer is shown in Figures 3(b) and 4(b).

[0055] Next, as shown in Figure 4(b), a bottom electrode 11 is deposited 42 onto the substrate 15. This electrode 11 is electrically conducting and can be magnetic or non-magnetic, depending on the choice of the device type as previously indicated above. Upon completion of this step, an electrically insulating layer 13 is deposited or grown 43 on top of the bottom electrode 11. This is illustrated in Figure 4(c). The thickness of the insulating layer 13 is at least

as large as a nanoparticle diameter which ranges from approximately 2 nm to approximately 20 nm in diameter.

[0056] Then, as shown in Figure 4(d), a top electrode 12 is deposited 44 on top of the insulating layer 13. The top electrode 12 is electrically conducting and may or may not be magnetic, depending on the type of device being fabricated. After this, the structure is patterned 45 and etched 46 so that a region of the insulating layer 13 is recessed and a space 5 between the two electrodes 11, 12 is opened up, as shown in Figure 4(e).

[0057] Next, in Figure 4(f), a layer of nanoparticles 9 is deposited 47 onto the structure such that the nanoparticles 9 fall in the exposed region 5 between the two electrodes 11, 12. The nanoparticles 9 are separated from each other by an insulating organic layer 10. The nanoparticle layer 9 may be either one or several layers thick, depending on the type of device being fabricated. Figure 4(f) shows only a single layer of nanoparticles 9 left in the empty space 5. In Figure 4(g), the substrate 15 is not shown on the device, wherein the substrate 15 may be removed 48, depending on the desired application. Again, the entire process is outlined in Figure 4(h).

[0058] The resistance of the device is sensitive to the presence or absence of a magnetic field. Figures 5(a) and 5(b) are plots of the device resistance versus the external magnetic field. As shown in Figures 5(a) and 5(b), the device resistance can be high ( $R_{\text{high}}$ ) or low ( $R_{\text{low}}$ ), depending on the amount of the magnetic field which is present. The difference in resistance between the ( $R_{\text{high}}$ ) or ( $R_{\text{low}}$ ) state is typically between 1% and 50%. The device response to an external field can be made as that which is shown in either Figure 5(a) or Figure 5(b), depending

on the magnetic properties of the nanoparticles comprising the device. The two different device resistances ( $R_{\text{high}}$  and  $R_{\text{low}}$ ) are used to distinguish the presence of a magnetic field.

[0059] The inventive structure (sensor) has several advantages over conventional devices. First, the critical dimension is about 5 to 50 nm and is well-matched to the bit area required for storage at areal densities  $>10$  Gbit/in<sup>2</sup>. Second, the critical dimension is 5 to 50 nm and is beyond the resolution of current lithographic methods, and is controlled through chemical size separation methods (not through deposition thickness control, and not through lithography). Also, the methods described herein are readily scaled to a large scale production, and the methods use less vacuum-based process equipment than the conventional devices and, hence, the present methods result in lower fabrication costs.

[0060] While the invention has been described in terms of preferred embodiments, those skilled in the art will recognize that the invention can be practiced with modification within the spirit and scope of the appended claims.

## CLAIMS

What is claimed is:

1. A magnetic-field sensor device comprising:
  - at least two electrodes;
  - an insulating layer separating said at least two electrodes; and
  - at least one layer of chemically-synthesized magnetic nanoparticles disposed between said at least two electrodes.
2. The magnetic-field sensor device of claim 1, wherein said at least two electrodes comprise a magnetic material.
3. The magnetic-field sensor device of claim 1, wherein at least one of said at least two electrodes comprises a magnetic material.
4. The magnetic-field sensor device of claim 1, wherein at least one of said at least two electrodes is one of a non-magnetic metal and a semiconductor.
5. The magnetic-field sensor device of claim 1, wherein said chemically-synthesized magnetic nanoparticles range in size between 2 nm and 20 nm in diameter.

1 6. The magnetic-field sensor device of claim 1, wherein said chemically-synthesized  
2 magnetic nanoparticles are oriented with a magnetic-moment orientation parallel to a direction of  
3 current flow through said chemically-synthesized magnetic nanoparticles.

1 7. The magnetic-field sensor device of claim 1, wherein said chemically-synthesized  
2 magnetic nanoparticles are oriented with a magnetic-moment orientation perpendicular to a  
3 direction of current flow through said chemically-synthesized magnetic nanoparticles.

1 8. The magnetic-field sensor device of claim 1, wherein said at least one layer of  
2 chemically-synthesized magnetic nanoparticles comprises at least one chemically-synthesized  
3 magnetic nanoparticle.

1 9. The magnetic-field sensor device of claim 1, wherein said chemically-synthesized  
2 magnetic nanoparticles comprise elements comprising one of Co, Fe, Ni, Mn, Cr, Nd, Pr, Pt, Pd,  
3 Ho, Gd, Eu, Er, Re, Rh, an intermetallic compound of said elements, a binary alloy of said  
4 elements, a ternary alloy of said elements, an oxide comprising one of Fe, Co, Ni, Mn, and Cr,  
5 and a mixed oxide combining at least one of Fe, Co, Ni, Mn, and Cr, with at least one of La, Sr,  
6 Ba, and Cu.

1 10. The magnetic-field sensor device of claim 1, wherein said insulating organic layer  
2 separates one chemically-synthesized magnetic nanoparticle layer from another chemically-  
3 synthesized magnetic nanoparticle layer.

1 11. A magnetic-field sensor device comprising:  
2 at least two electrodes;  
3 an insulating layer separating said at least two electrodes; and  
4 at least one layer of chemically-synthesized magnetic nanoparticles disposed between said  
5 at least two electrodes;  
6 wherein said at least two electrodes comprise a magnetic material.

12. The magnetic-field sensor device of claim 11, wherein at least one of said at least two  
electrodes comprises a magnetic material.

13. The magnetic-field sensor device of claim 11, wherein at least one of said at least two  
electrodes is one of a non-magnetic metal and a semiconductor.

14. The magnetic-field sensor device of claim 11, wherein said chemically-synthesized  
magnetic nanoparticles range in size between 2 nm and 20 nm in diameter.

15. The magnetic-field sensor device of claim 11, wherein said chemically-synthesized  
magnetic nanoparticles are oriented with a magnetic-moment orientation parallel to a direction of  
current flow through said chemically-synthesized magnetic nanoparticles.

1 16. The magnetic-field sensor device of claim 11, wherein said chemically-synthesized  
2 magnetic nanoparticles are oriented with a magnetic-moment orientation perpendicular to a  
3 direction of current flow through said chemically-synthesized magnetic nanoparticles.

1 17. The magnetic-field sensor device of claim 11, wherein said at least one layer of  
2 chemically- synthesized magnetic nanoparticles comprises at least one chemically-synthesized  
3 magnetic nanoparticle.

1 18. The magnetic-field sensor device of claim 11, wherein said chemically-synthesized  
2 magnetic nanoparticles comprise elements comprising one of Co, Fe, Ni, Mn, Cr, Nd, Pr, Pt, Pd,  
3 Ho, Gd, Eu, Er, Re, Rh, an intermetallic compound of said elements, a binary alloy of said  
4 elements, a ternary alloy of said elements, an oxide comprising one of Fe, Co, Ni, Mn, and Cr,  
5 and a mixed oxide combining at least one of Fe, Co, Ni, Mn, and Cr, with at least one of La, Sr,  
6 Ba, and Cu.

1 19. The magnetic-field sensor device of claim 10, wherein said insulating organic layer  
2 separates one chemically-synthesized magnetic nanoparticle layer from another chemically-  
3 synthesized magnetic nanoparticle layer.

1 20. A method of forming a magnetic-field sensor device, said method comprising:  
2 depositing a first electrode onto a substrate;  
3 depositing an electrically insulating layer on said first electrode;



removing a portion of said electrically insulating layer to expose a region of said first electrode;

depositing at least one layer of chemically-synthesized nanoparticles on said electrically insulating layer and said exposed region of said first electrode; and

depositing a second electrode on said chemically-synthesized nanoparticles and said electrically insulating layer.

21. The method of claim 20, wherein said substrate comprises one of a conducting material and a non-conducting material.

22. The method of claim 20, wherein said first and second electrodes comprise an electrically conducting and magnetic material.

23. The method of claim 20, further comprising depositing a layer of magnetic material on said substrate.

24. The method of claim 20, wherein said chemically-synthesized nanoparticles comprise elements comprising one of Co, Fe, Ni, Mn, Cr, Nd, Pr, Pt, Pd, Ho, Gd, Eu, Er, Re, Rh, an intermetallic compound of said elements, a binary alloy of said elements, a ternary alloy of said elements, an oxide comprising one of Fe, Co, Ni, Mn, and Cr, and a mixed oxide combining at least one of Fe, Co, Ni, Mn, and Cr, with at least one of La, Sr, Ba, and Cu.

1 25. A method of forming a magnetic-field sensor device, said method comprising:  
2 depositing a first electrode onto a substrate;  
3 depositing an electrically insulating layer on said first electrode;  
4 depositing a second electrode on said electrically insulating layer;  
5 removing a portion of said electrically insulating layer to create an empty space;  
6 depositing at least one layer of chemically-synthesized nanoparticles in said empty space;  
7 and  
8 removing said substrate.

9  
10  
11 26. The method of claim 25, wherein said substrate comprises one of a conducting material  
12 and a non-conducting material.

13  
14  
15 27. The method of claim 25, wherein said first and second electrodes comprise an electrically  
16 conducting and magnetic material.

17  
18  
19 28. The method of claim 25, wherein said chemically-synthesized nanoparticles comprise  
20 elements comprising one of Co, Fe, Ni, Mn, Cr, Nd, Pr, Pt, Pd, Ho, Gd, Eu, Er, Re, Rh, an  
21 intermetallic compound of said elements, a binary alloy of said elements, a ternary alloy of said  
22 elements, an oxide comprising one of Fe, Co, Ni, Mn, and Cr, and a mixed oxide combining at  
23 least one of Fe, Co, Ni, Mn, and Cr, with at least one of La, Sr, Ba, and Cu.

# MAGNETIC-FIELD SENSOR HAVING MAGNETIC NANOPARTICLES

## ABSTRACT

5 A structure and method for forming a magnetic-field sensor device comprises depositing  
a first electrode onto a substrate. Then, an electrically insulating layer is deposited on the first  
electrode. Next, a portion of the insulating layer is removed to expose a region of the first  
electrode, thereby creating an empty space. After this, at least one layer of  
chemically-synthesized nanoparticles is deposited on the insulating layer and within the empty  
space. Next, a second electrode is deposited on both the layer of nanoparticles and the insulating  
layer. Alternatively, multiple layers of nanoparticles may be deposited, or only a single  
nanoparticle may be deposited. The substrate is either conducting or non-conducting, and the  
first and second electrodes are electrically conducting and may be magnetic or non-magnetic.  
Additionally, a metallic layer of magnetic material may be first deposited on the substrate.

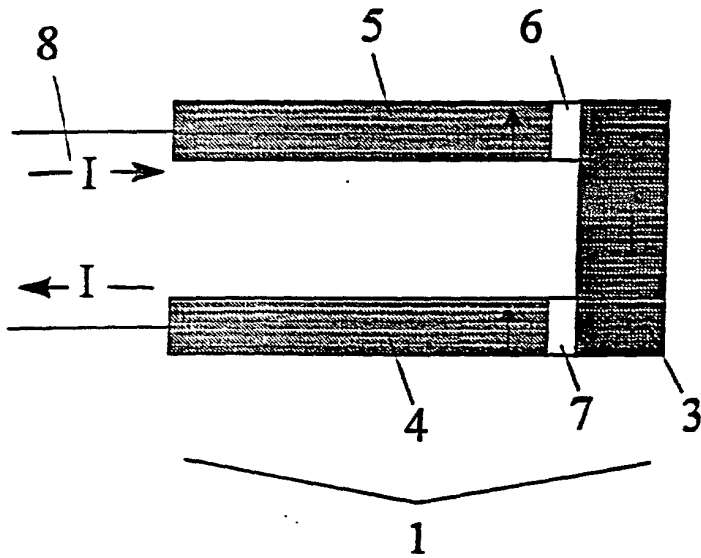


Fig. 1(a)

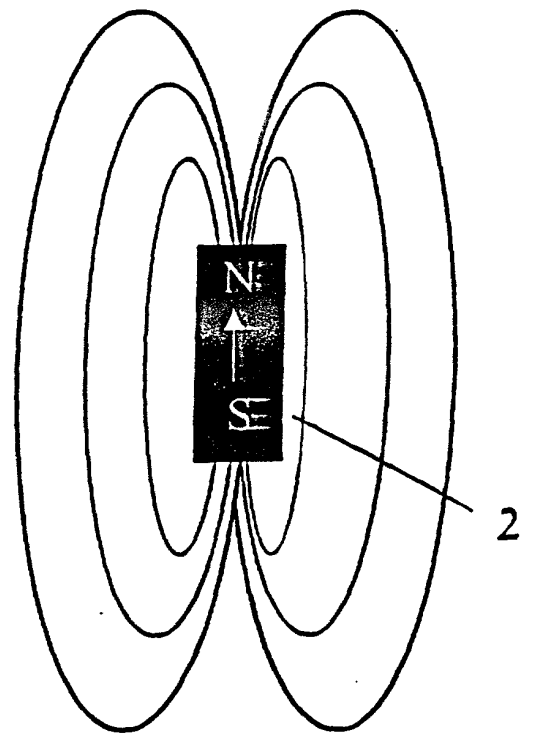


Fig. 1(b)

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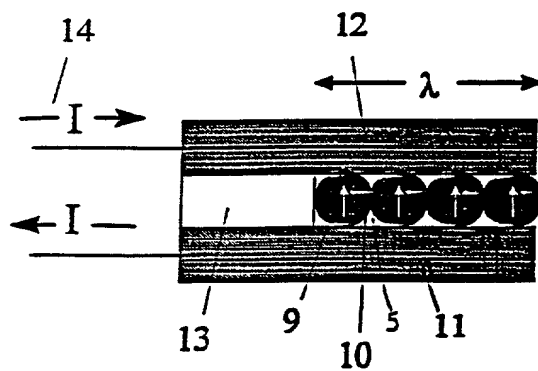


Fig. 2(a)

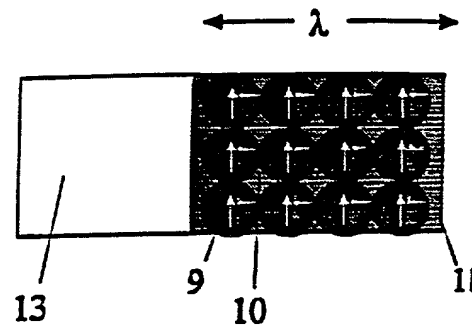


Fig. 2(b)



Fig. 2(c)

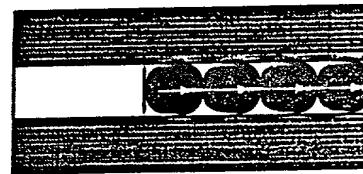


Fig. 2(d)

Fig. 3(a)



Fig. 3(b)

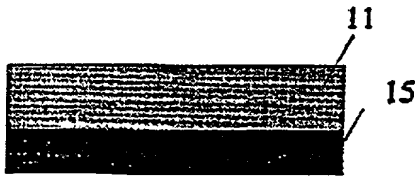


Fig. 3(c)

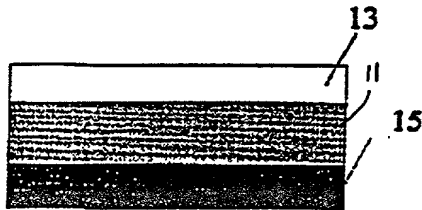


Fig. 3(d)

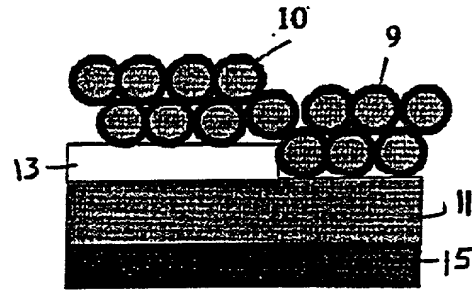
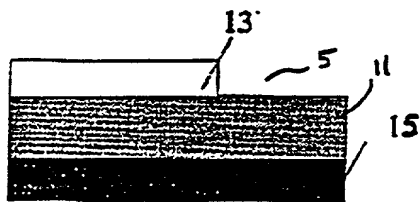


Fig. 3(e)

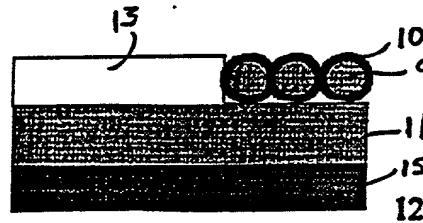


Fig. 3(f)

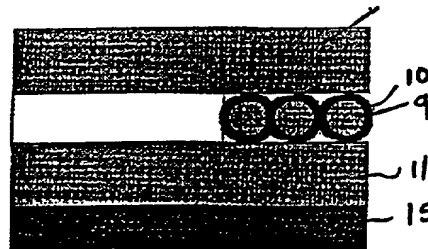


Fig. 3(g)

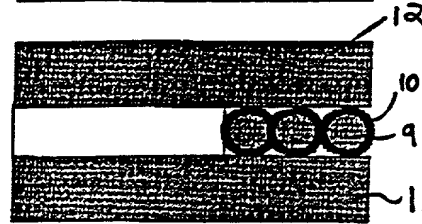


Fig. 3(h)

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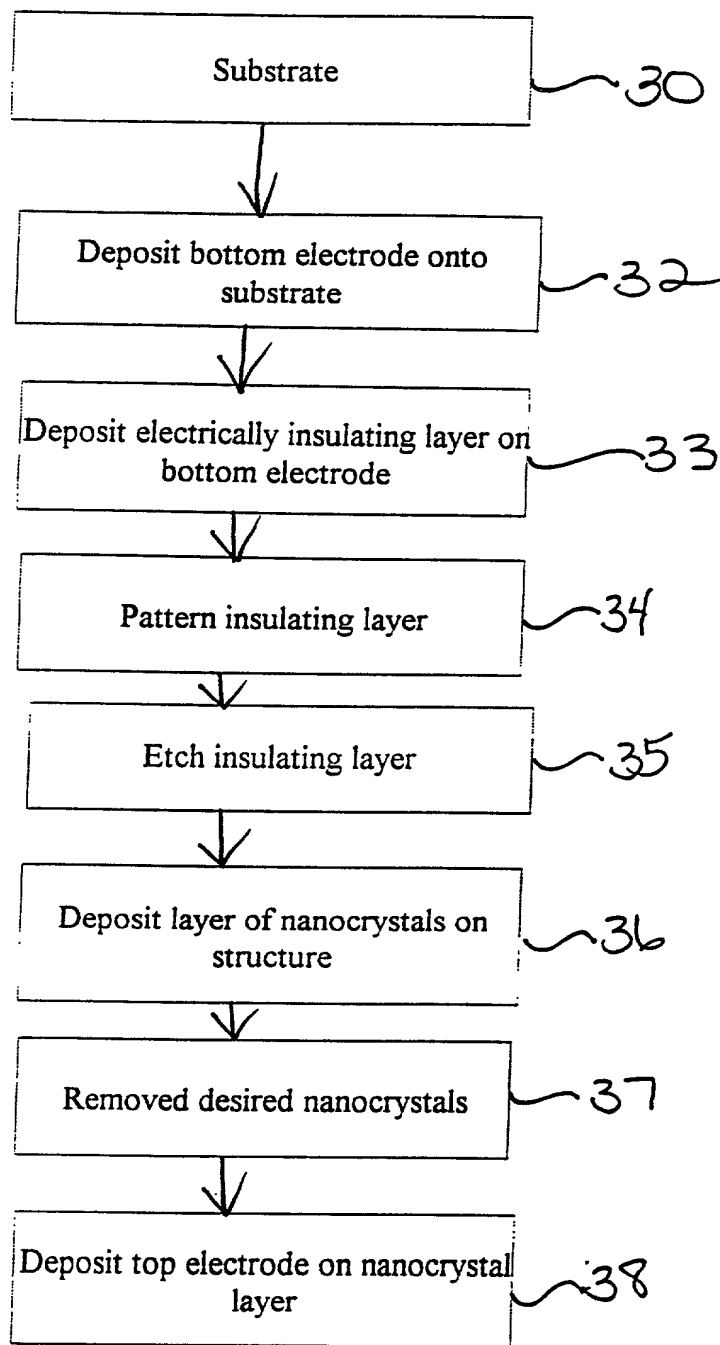


Fig. 3(i)

Fig. 4(a)



Fig. 4(b)

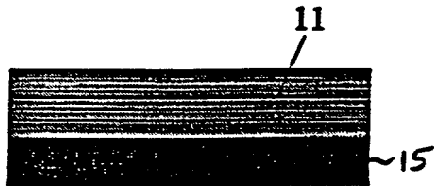


Fig. 4(c)

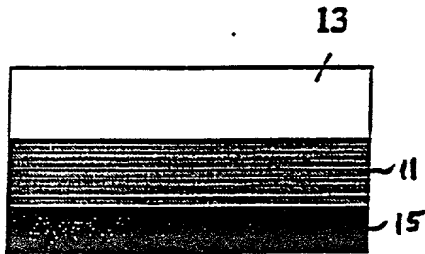
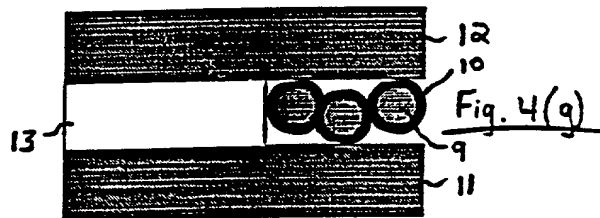
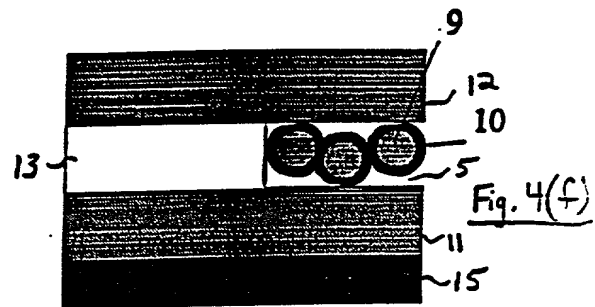
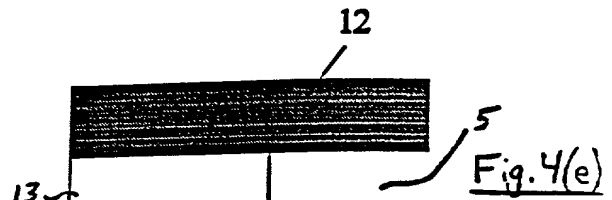
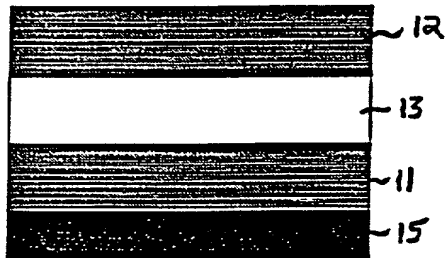
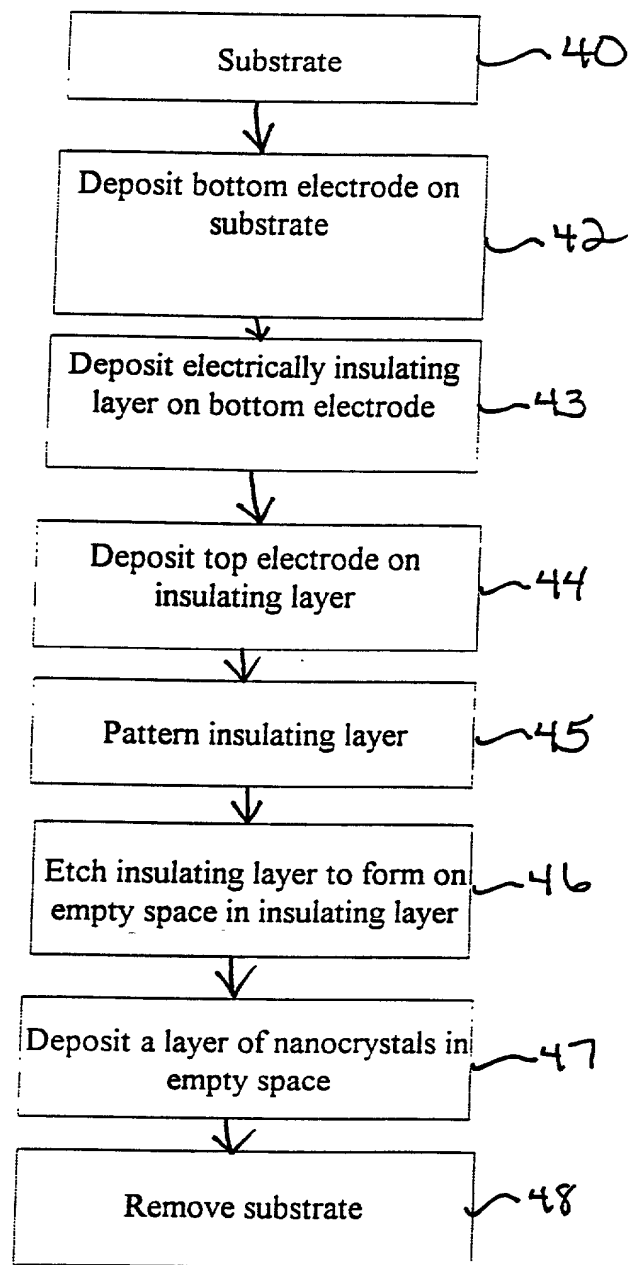


Fig. 4(d)







**Fig. 4 (h)**

Fig. 5(a)

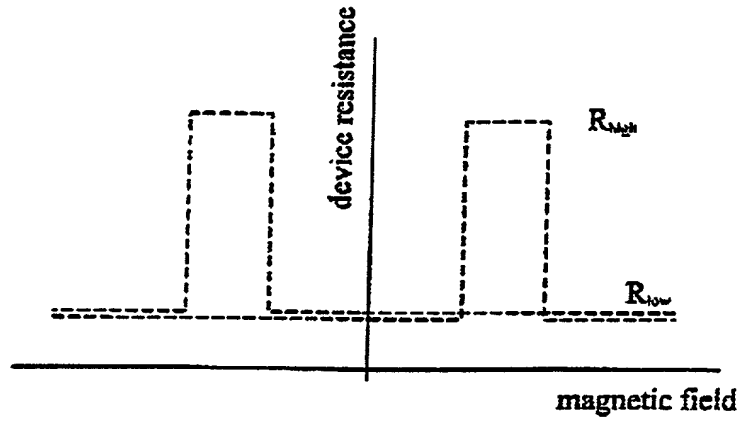
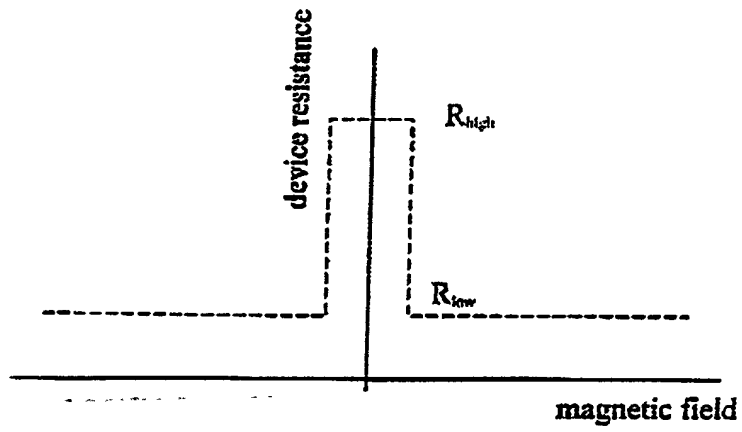


Fig. 5(b)



## DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **MAGNETIC-FIELD SENSOR HAVING MAGNETIC NANOPARTICLES**

the specification of which: (check one)

☒ is attached hereto.

☐ was filed on \_\_\_\_\_, as Application Serial No. \_\_\_\_\_ and was amended on \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Day/Month/Year	Priority Claimed
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I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Applications:

Serial No.	Filing Date	Status
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

As a named inventor, I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: We hereby appoint Manny Schecter (Reg. No. 31,722), Lauren Bruzzzone (Reg. No. 35,082), Christopher A. Hughes (Reg. No. 26,914), John E. Hoel (Reg. No. 26,279), Joseph C. Redmond, Jr. (Reg. No. 18,753), Richard M. Ludwin (Reg. No. 33,010), Marc A. Erlich (Reg. No. 39,966), Douglas W. Cameron (Reg. No. 31,596), Louis P. Herzberg (Reg. No. 41,500), Marian Underweiser (Reg. No. 46,134), Stephen C. Kaufman (Reg. No. 29,551), Daniel P. Morris (Reg. No. 32,053), Louis J. Percello (Reg. No. 33,206), Robert M. Trepp (Reg. No. 25, 933), Gail H. Zarick (Reg. No. 43,303), Robert P. Tassinari, Jr. (Reg. No. 36,030), Paul J. Otterstedt (Reg. No. 37,411), Derek S. Jennings (Reg. No. 41,473) and Timothy M. Farrell (Reg. No. 37,321) to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith.

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